

Multilayer Ceramic Chip Capacitors

CGA4J1X7R1V225M125AE



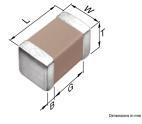






TDK item description CGA4J1X7R1V225MT***S

Applications	Automotive Grade	
Feature	Soft Termination AEC-Q200 AEC-Q200	
Series	CGA4(2012) [EIA 0805]	
Status	Production	



	Size
Length(L)	2.00mm +0.45,-0.20mm
Width(W)	1.25mm +0.25,-0.20mm
Thickness(T)	1.25mm +0.25,-0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	0.50mm Min.
Recommended Land Pattern (PA)	1.00mm to 1.30mm(Flow Soldering)
recommended Land Factern (FA)	0.90mm to 1.20mm(Reflow Soldering)
Recommended Land Pattern (PB)	1.00mm to 1.20mm(Flow Soldering)
necommended Land Factern (FB)	0.70mm to 0.90mm(Reflow Soldering)
Recommended Land Pattern (PC)	0.80mm to 1.10mm(Flow Soldering)
neconfinenced Land Fattern (FC)	0.90mm to 1.20mm(Reflow Soldering)

Elec	rical Characteristics
Capacitance	2.2μF ±20%
Rated Voltage	35VDC
Temperature Characteristic	X7R(±15%)
Dissipation Factor (Max.)	5%
Insulation Resistance (Min.)	227ΜΩ

Other		
Coldoring Mothod	Wave (Flow)	
Soldering Method	Reflow	
AEC-Q200	Yes	
Packing	Blister (Plastic)Taping [180mm Reel]	
Package Quantity	2000pcs	

[!] Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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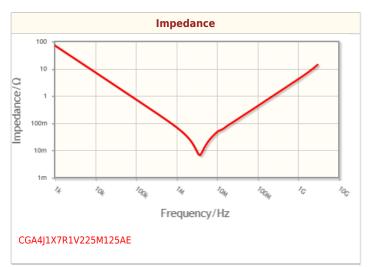


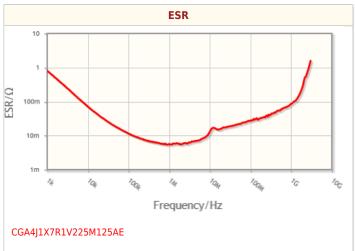


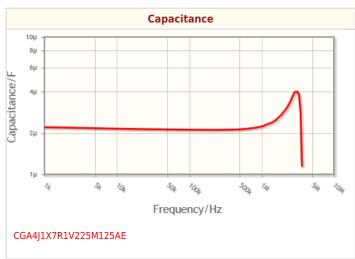


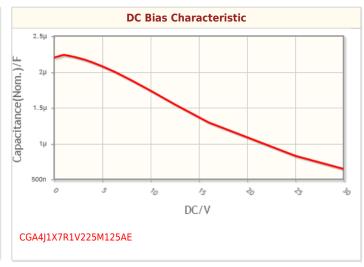


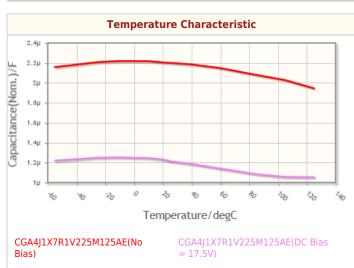
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

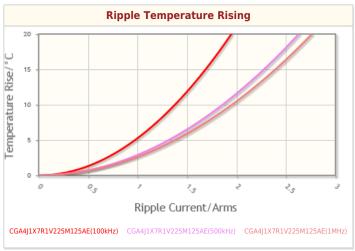












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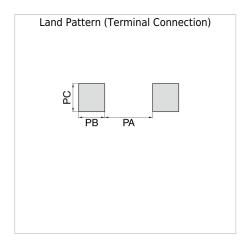








Associated Images



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